

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT3716374

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HSIN-PING CHEN	01/22/2016
CARLOS H. DIAZ	01/22/2016
KEN-ICHI GOTO	01/22/2016
SHAU-LIN SHUE	01/22/2016
TAI-I YANG	01/22/2016
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15007852
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NAME OF SUBMITTER:	TAN TU
SIGNATURE:	/Tu T. Tan/
DATE SIGNED:	01/27/2016
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, Hsin-Ping CHEN, Carlos H. DIAZ, Ken-Ichi GOTO, Shau-Lin SHUE, and Tai-I YANG

hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **NANO-ELECTROMECHANICAL SYSTEM (NEMS) DEVICE STRUCTURE AND METHOD FOR FORMING THE SAME**

Filed: January 27, 2016 Serial No. 15/007,852

Executed on: January 22, 2016

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd., of No. 8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu 300-78, Taiwan R.O.C., hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

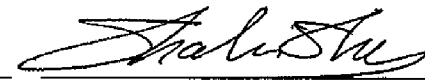
IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

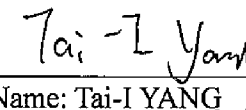
ASSIGNMENT

01/22/2016 
Date Name: Hsin-Ping CHEN (Last name: CHEN)

1/22/2016 
Date Name: Carlos H. DIAZ (Last name: DIAZ)

2016. 1. 22 
Date Name: Ken-Ichi GOTO (Last name: GOTO)

2016. 1. 22 
Date Name: Shau-Lin SHUE (Last name: SHUE)

2016. 1. 22 
Date Name: Tai-I YANG (Last name: YANG)